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IGBT - Field Stop II NGTB35N65FL2WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb-Free Devices

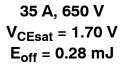
Typical Applications

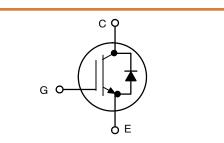
- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector-emitter Voltage	V _{CES}	650	V	
Collector Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	I _C	70 35	A	
Diode Forward Current @ T _C = 25°C @ T _C = 100°C	I _F	70 35	A	
Diode Pulsed Current T_{PULSE} Limited by T_J Max	I _{FM}	I _{FM} 120		
Pulsed Collector Current, T _{pulse} Limited by T _{Jmax}	ulsed Collector Current, T _{pulse} I _{CM} 120 mited by T _{Jmax}		A	
Short-circuit Withstand Time V_{GE} = 15 V, V_{CE} = 400 V, $T_J \le +150^{\circ}C$	t _{SC}	5	μs	
Gate-emitter Voltage	V _{GE}	±20	V	
Transient Gate-emitter Voltage (T _{PULSE} = 5 μs, D < 0.10)		±30	V	
Power Dissipation @ T _C = 25°C @ T _C = 100°C	P _D	300 150	W	
Operating Junction Temperature Range	TJ	–55 to +175	°C	
Storage Temperature Range	T _{stg}	–55 to +175	°C	
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C	

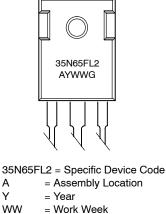
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







MARKING DIAGRAM



= Pb-Free Package

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ORDERING INFORMATION

Device	Package	Shipping
NGTB35N65FL2WG	TO-247 (Pb-Free)	30 Units / Rail

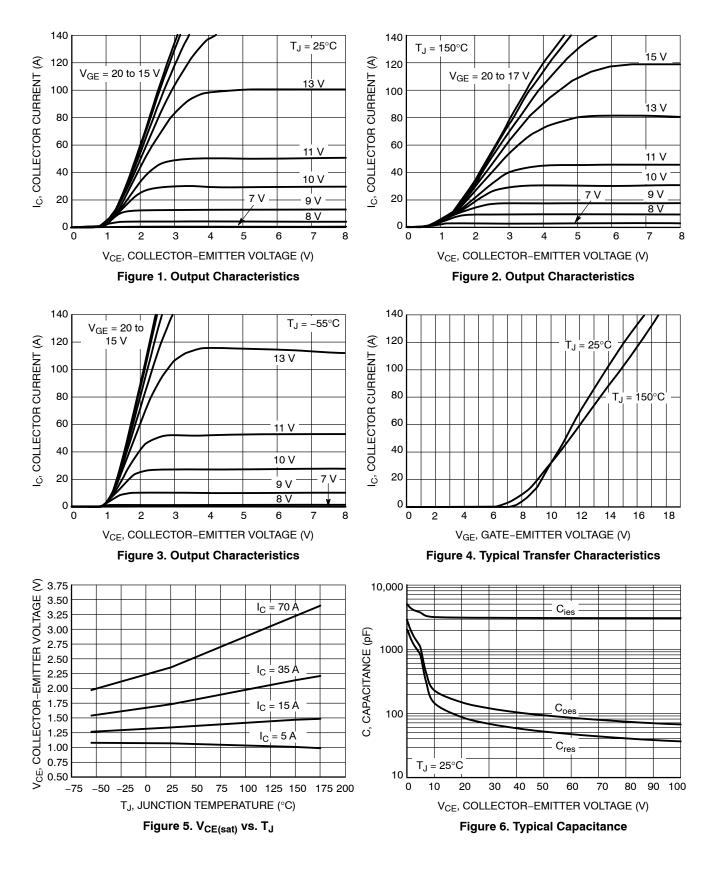
THERMAL CHARACTERISTICS

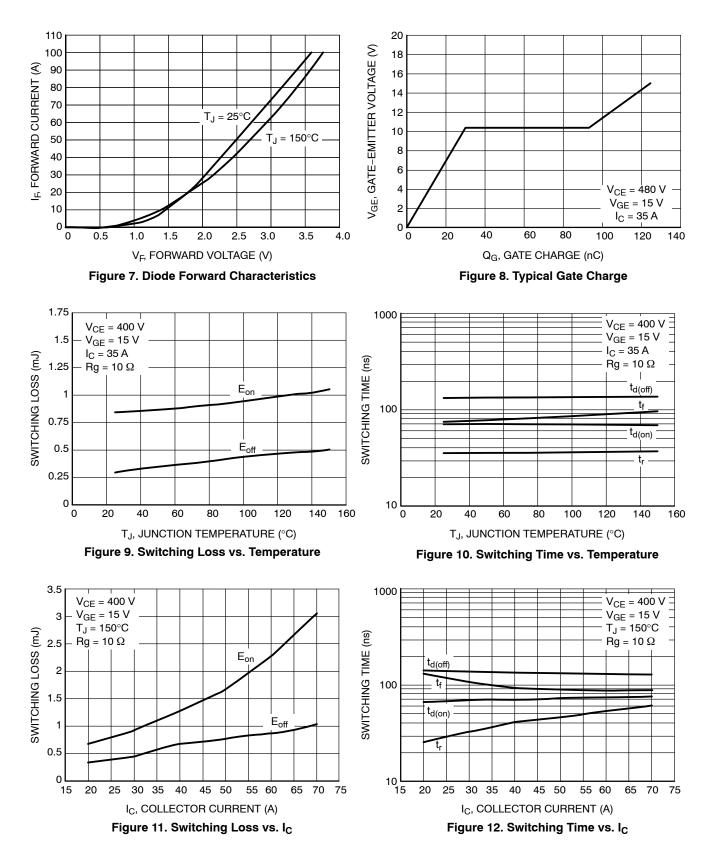
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.50	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.00	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

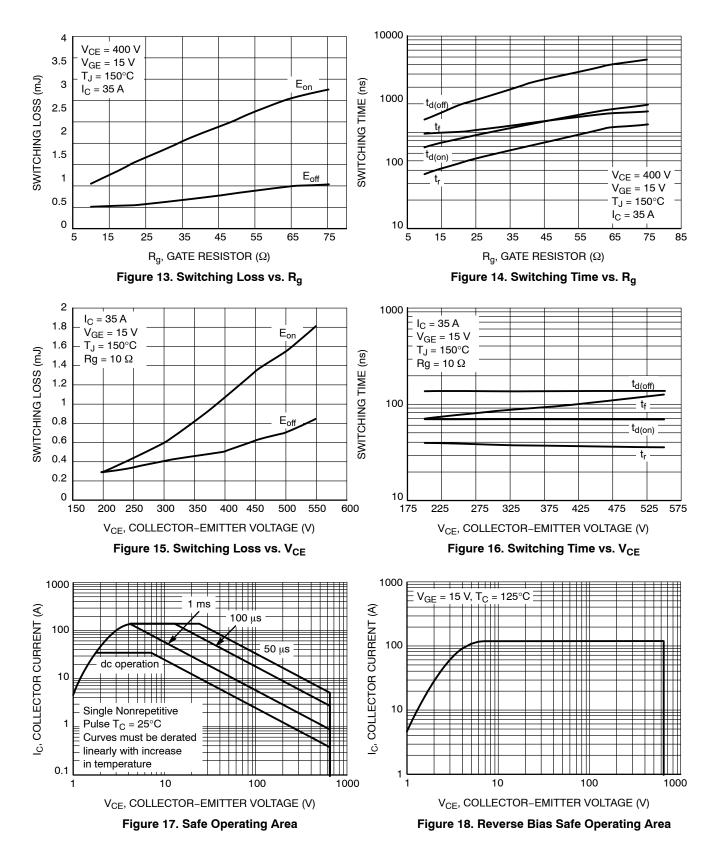
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

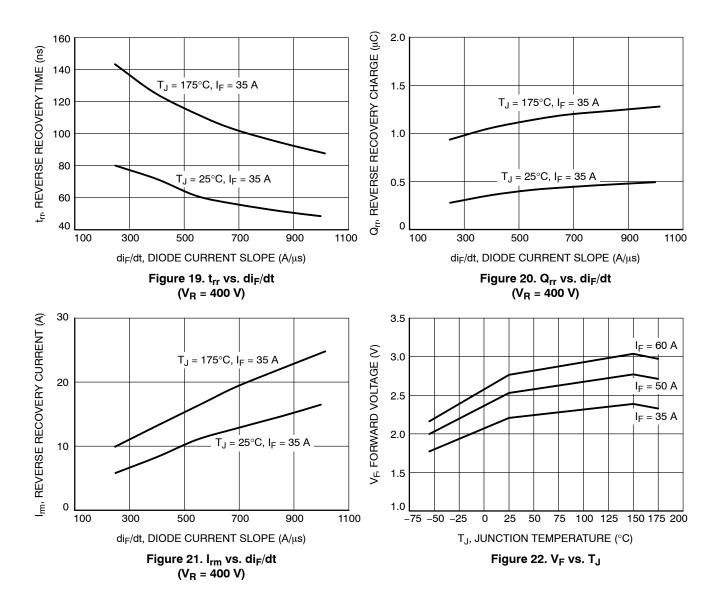
Parameter	Parameter Test Conditions		Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	-	-	-	-	-
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	650	_	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 35 A V_{GE} = 15 V, I _C = 35 A, T _J = 175°C	V _{CEsat}	1.50 -	1.70 2.20	2.00	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 350 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V_{GE} = 0 V, V_{CE} = 650 V V_{GE} = 0 V, V_{CE} = 650 V, T_{J} = 175°C	I _{CES}			0.5 4.0	mA
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V , V _{CE} = 0 V	I _{GES}	-	-	200	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	3115	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	149	-	
Reverse transfer capacitance		C _{res}	-	88	-	
Gate charge total		Qg	-	125	-	nC
Gate to emitter charge	V_{CE} = 480 V, I_{C} = 35 A, V_{GE} = 15 V	Q _{ge}	-	30	-	
Gate to collector charge	1	Q _{gc}	-	63	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	72	_	ns
Rise time	1	t _r	-	40	-	1
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	132	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 35 \text{ A}$ $R_{g} = 10 \Omega$	t _f	_	75	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V$	Eon	-	0.84	-	mJ
Turn-off switching loss		E _{off}	-	0.28	-	
Total switching loss		E _{ts}	-	1.12	-	
Turn-on delay time		t _{d(on)}	-	70	-	ns
Rise time		t _r	-	38	-	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	135	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 35 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	96	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V$	E _{on}	-	1.05	-	mJ
Turn-off switching loss		E _{off}	-	0.50	-	
Total switching loss		E _{ts}	-	1.55	-	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 35 A V_{GE} = 0 V, I _F = 35 A, T _J = 175°C	V _F	1.50 -	2.20 2.25	2.90 -	V
Reverse recovery time	T.I = 25°C	t _{rr}	-	68	-	ns
Reverse recovery charge	I _F = 35 Å, V _R = 200 V	Q _{rr}	-	265	-	nC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	-	7	-	А
Reverse recovery time	T,₁ = 175°C	t _{rr}	-	156	-	ns
Reverse recovery charge	I _F = 35 Å, V _R = 400 V	Q _{rr}	-	836	-	nC
Reverse recovery current	di _F /dt = 200 A/μs	I _{rrm}	_	8.43	_	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.









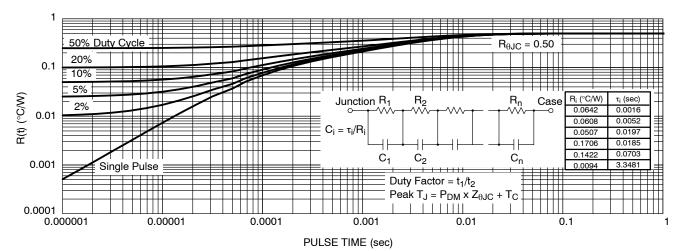


Figure 23. IGBT Transient Thermal Impedance

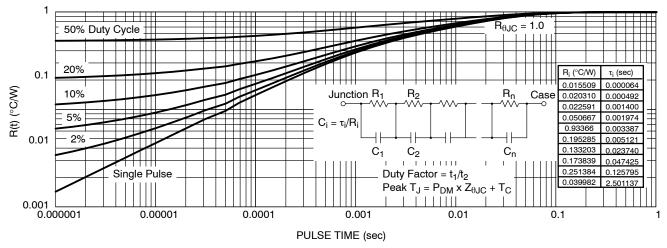
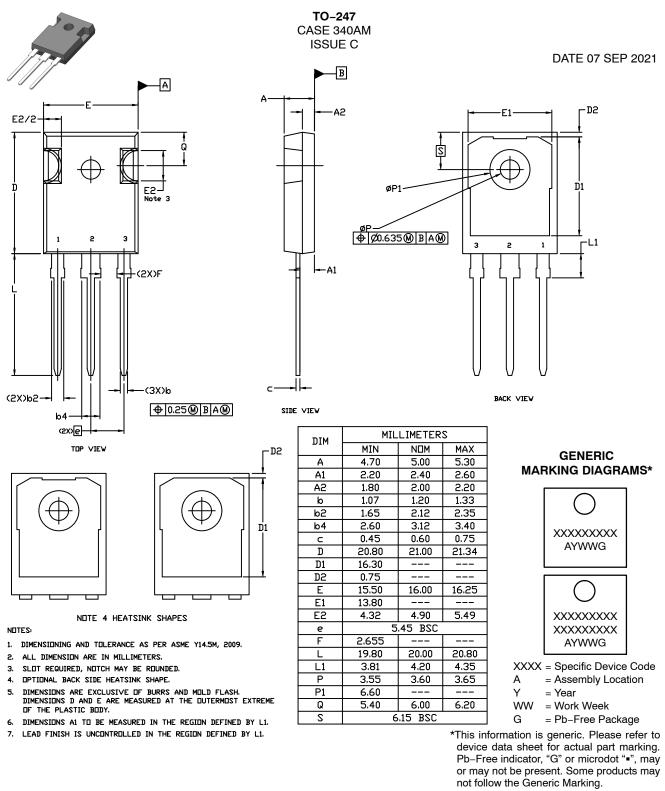


Figure 24. Diode Transient Thermal Impedance

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